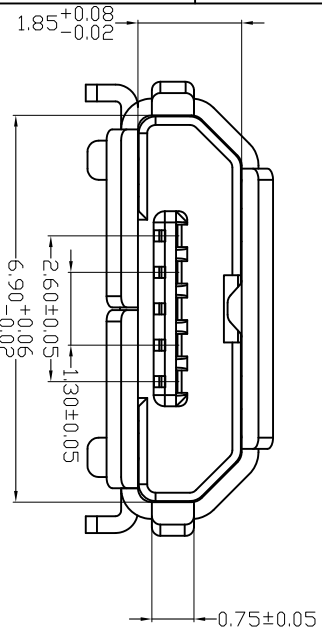


PCB LAYOUT

Note:

1. Material:
 - 1.1 Housing: High temperature thermoplastic with g.f.,UL94V-0
 - 1.2 Contact: copper alloy,t=0.15mm
 - 1.3 Shell: copper alloy&SUS
2. Specification:
 - 2.1 Current rating: 1 A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 30 mΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min,0.81~2.05 Kgf Min,after 10000 insertion/extraction cycles
 - 2.7 Temperature range: -30°C~80°C



产品图
PRODUCT CHART DWG

深圳市精拓金电子有限公司

公差一览表		单位		制图		制图料号	
TOLERANCE	UNLESS OTHERWISE	UNITS	MM	DRAWING	审核	PRODUCT PART NO.	角法
X	±0.15	X	±5°	审核	郭治富	MICRO 5P/F B 反向牛角	内DIP 0.6(7.7*5.3)
X	±0.10	X	±2°	核准	黄国荣	PRODUCT NO.	VER
XX	±0.05	XX	±1°	DATE	2016-09-09	角法	AD
XXX	±0.03	XXX	±0.5°	APPRO		VER	